

AUTOMOTIVE GRADE

AUIRGDC0250

Features

- Low V_{CE (on)} Planar IGBT Technology
- Low Switching Losses
- Square RBSOA
- 100% of the Parts Tested for ILM
- Positive V_{CE (on)} Temperature Coefficient •
- Reflow Capable per JDSD22-A113
- Lead-Free, RoHS Compliant
- Automotive Qualified *

Benefits

- Device optimized for soft switching applications
- High Efficiency due to Low V_{CE(on)}, low switching losses
- Rugged transient performance for increased reliability
- Excellent current sharing in parallel operation
- Low EMI

Application

- PTC Heater
- Relay Replacement

G n-channel	$V_{CES} = 1200V$ $I_{C} = 81A @ T_{C} = 100^{\circ}C$ $V_{CE(on)}$ typ. = 1.47V @ 33A
J	



G	С	E
Gate	Collector	Emitter

Base Bart Number	Dookogo Turo	Standard P	Orderable Part Number	
Base Part Number	Package Type	Form	Quantity	Orderable Part Number
AUIRGDC0250	Super-TO-220	Tube	50	AUIRGDC0250

Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T_A) is 25°C, unless otherwise specified.

	Parameter	Max.	Units
V _{CES}	Collector-to-Emitter Voltage	1200	V
I _C @ T _C = 25°C	Continuous Collector Current	141④	
I _C @ T _C = 100°C	Continuous Collector Current	81	
I _{CM}	Pulse Collector Current, V _{GE} = 15V ②	99	Α
I _{LM}	Clamped Inductive Load Current, V _{GE} = 20V ①	99	
V _{GE}	Continuous Gate-to-Emitter Voltage	±20	V
	Transient Gate-to-Emitter Voltage	±30	v
P _D @ T _C = 25°C	Maximum Power Dissipation	543	w
P _D @ T _C = 100°C	Maximum Power Dissipation	217	vv
TJ	Operating Junction and	-55 to +150	
T _{STG}	Storage Temperature Range		°C
	Soldering Temperature, for 10 sec. (Through Hole Mounting)	300 (0.063 in. (1.6mm) from case)	

Thermal Resistance

	Parameter	Тур.	Max.	Units
R _{θJC} (IGBT)	Thermal Resistance Junction-to-Case (each IGBT) ③		0.23	
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink (flat, greased surface)	0.50		°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction-to-Ambient (typical socket mount)		62	

* Qualification standards can be found at www.infineon.com



Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)CES}	Collector-to-Emitter Breakdown Voltage	1200			V	$V_{GE} = 0V, I_{C} = 250\mu A$
$\Delta V_{(BR)CES} / \Delta T_J$	Temperature Coeff. of Breakdown Voltage	_	1.2	_	V/°C	V _{GE} = 0V, I _C = 1mA (25°C-150°C)
V _{CE(on)}	Collector-to-Emitter Saturation Voltage	_	1.47	1.8	V	I_{C} = 33A, V_{GE} = 15V, T_{J} = 25°C
			1.56		v	I _C = 33A, V _{GE} = 15V, T _J = 150°C
$V_{GE(th)}$	Gate Threshold Voltage	3.0		6.0	V	V_{CE} = V_{GE} , I_C = 250 μ A
$\Delta V_{GE(th)} / \Delta T J$	Threshold Voltage temp. coefficient		-15		mV/°C	$V_{CE} = V_{GE}$, $I_C = 250 \mu A (25^{\circ}C-150^{\circ}C)$
gfe	Forward Transconductance		30		S	V_{CE} = 50V, I_{C} = 33A,PW = 20µS
I _{CES}	Collector-to-Emitter Leakage Current	_	_	250		V_{GE} = 0V, V_{CE} = 1200V, T_{J} = 25°C
		_	_	1000	μA	V _{GE} = 0V, V _{CE} = 1200V,T _J = 150°C
I _{GES}	Gate-to-Emitter Leakage Current			±100	nA	V _{GE} = ±20V

Switching Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
Q _g	Total Gate Charge (turn-on)	—	151	227		I _C = 33A
Q_{ge}	Gate-to-Emitter Charge (turn-on)	—	26	39	nC	V _{GE} = 15V
Q _{gc}	Gate-to-Collector Charge (turn-on)		62	93		V _{CC} = 600V
E _{off}	Turn-Off Switching Loss	—	15	16	mJ	I_{C} = 33A, V_{CC} = 600V, V_{GE} = 15V
t _{d(off)}	Turn-Off delay time	—	485	616	ns	$R_{G} = 5\Omega, L = 400\mu H, T_{J} = 25^{\circ}C$
t _f	Fall time	_	1193	1371	115	Energy losses include tail
E _{off}	Turn-Off Switching Loss	—	29	_	mJ	I_{C} = 33A, V_{CC} = 600V, V_{GE} = 15V
t _{d(off)}	Turn-Off delay time	_	689	_	ns	R_{G} = 5Ω, L = 400µH, T _J = 150°C
t _f	Fall time	_	2462	_	115	Energy losses include tail
C _{ies}	Input Capacitance	—	3804	_		V _{GE} = 0V
C _{oes}	Output Capacitance	—	161	—	pF	$V_{CC} = 30V$
C _{res}	Reverse Transfer Capacitance	—	31	—		f = 1.0Mhz
						T _J = 150°C, I _C = 99A
RBSOA	Reverse Bias Safe Operating Area		L SQUA	ARE		V _{CC} = 960V, Vp ≤ 1200V
						Rg = 5 Ω , V _{GE} = +20V to 0V

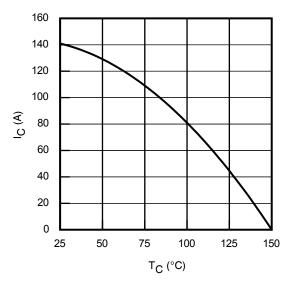
Notes:

Pulse width limited by max. junction temperature.

③ R_{θ} is measured at T_J approximately 90°C.

④ Calculated continuous current based on maximum allowable junction temperature. Bond wire current limit is 78A. Note that current limitations arising from heating of the device leads may occur with some lead mounting arrangements.







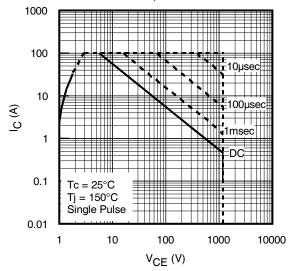


Fig. 3 - Forward SOA $T_C = 25^{\circ}C, T_J \le 150^{\circ}C; V_{GE} = 15V$ 100 (e) 100 (f) 100 100 100 $V_{CE}(V)$ Fig. 5 - Reverse Bias SOA $T_J = 150^{\circ}C; V_{GE} = 20V$

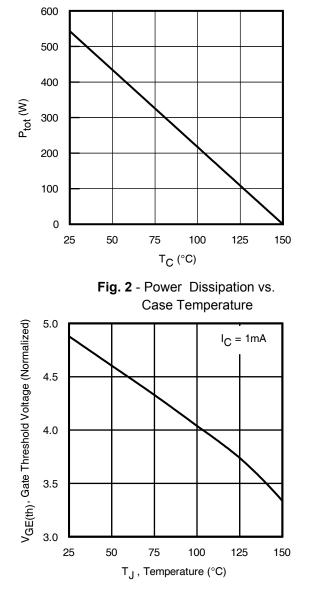
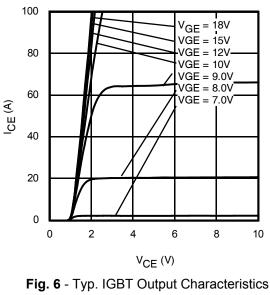
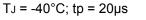
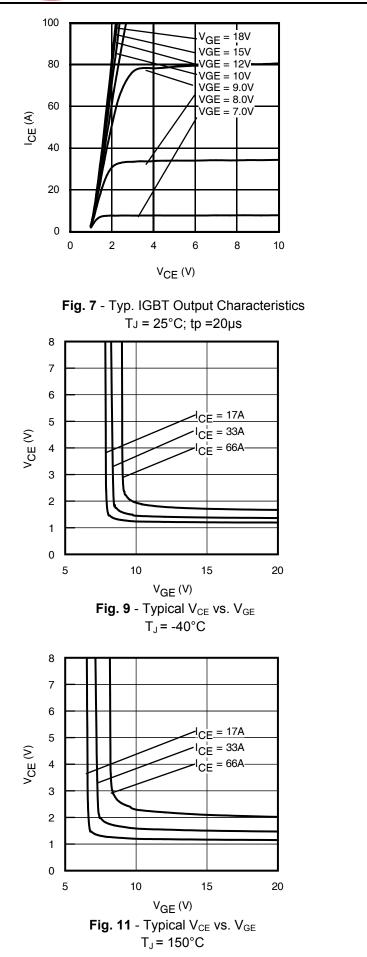


Fig. 4 - Typical Gate Threshold Voltage (Normalized) vs. Junction Temperature









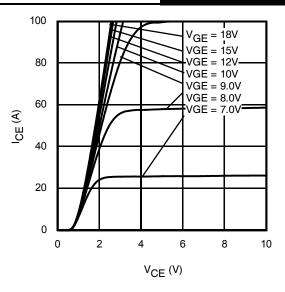


Fig. 8 - Typ. IGBT Output Characteristics TJ = 150° C; tp = 20μ s

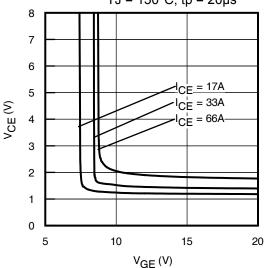
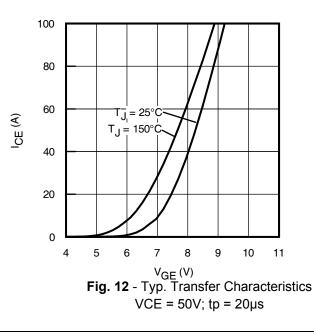


Fig. 10 - Typical V_{CE} vs. V_{GE} T_J = 25°C





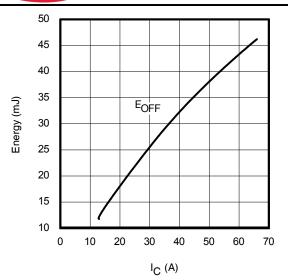


Fig. 13 - Typ. Energy Loss vs. I_C T_J = 150°C; L = 400 µH; V_{CE} = 600V, R_G = 5Ω; V_{GE} = 15V

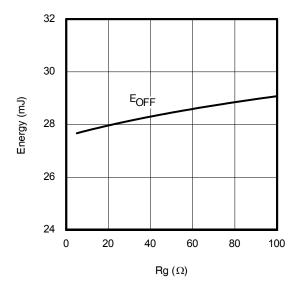
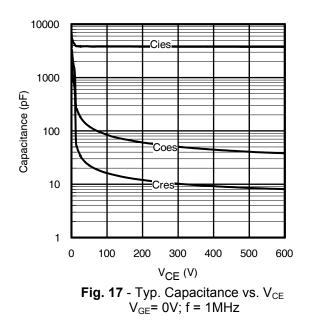


Fig. 15 - Typ. Energy Loss vs. R_G T_J = 150°C; L = 400µH; V_{CE} = 600V, I_{CE} = 33A; V_{GE} = 15V



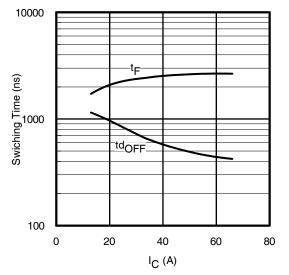


Fig. 14 - Typ. Switching Time vs. I_C T_J = 150°C; L = 400µH; V_{CE} = 600V, R_G = 5 $\Omega;$ V_{GE} = 15V

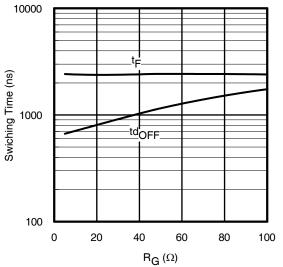
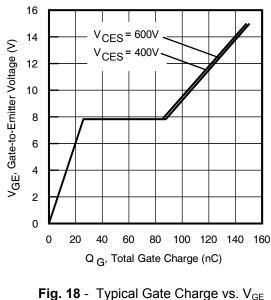


Fig. 16 - Typ. Energy Loss vs. R_G T_J = 150°C; L = 400µH; V_{CE} = 600V, I_{CE} = 33A; V_{GE} = 15V



 r_{IGE} - Typical Gate Charge VS. V_{GI} I_{CE} = 33A; L = 2.0mH



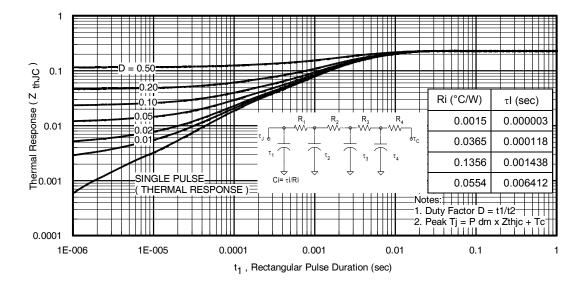
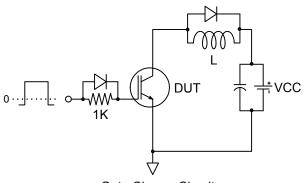


Fig 19. Maximum Transient Thermal Impedance, Junction-to-Case (IGBT)





Gate Charge Circuit

Fig.C.T.1 - Gate Charge Circuit (turn-off)

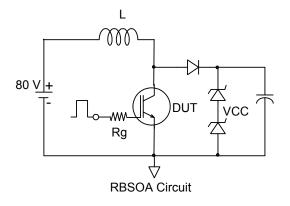


Fig.C.T.2 - RBSOA Circuit

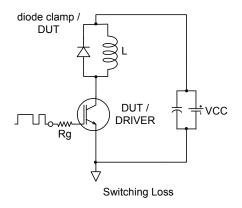


Fig.C.T.3 - Switching Loss Circuit

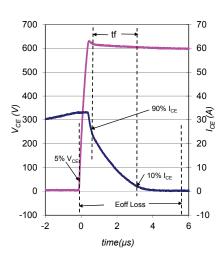
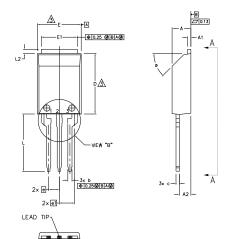


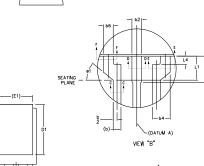
Fig. WF1 - Typ. Turn-off Loss Waveform @ T_J = 150°C using Fig. CT.3

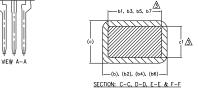


Super-TO-220 Package Outline

Dimensions are shown in millimeters (inches)







NOTES:

1. DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M-1994

2. DIMENSIONS 61, 63, 65 & c1 APPLY TO BASE METAL ONLY.

DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.127 [.005"] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTER EXTREMES OF THE PLASTIC BODY.

4.- ALL DIMENSIONS SHOWN IN MILLIMETERS.

5.- CONTROLLING DIMENSION: MILLIMETER.

6.- OUTLINE CONFORMS TO JEDEC OUTLINE TO-273AA.

S Y M	DIMENSIONS				N
B O	MILLIM	ETERS	INC	HES	N O T E S
L	MIN.	MAX.	MIN.	MAX.	S
А	4.34	4.74	.171	.187	
A1	0.50	1.00	.020	.039	
A2	2.50	3.00	.098	.118	
b	0.90	1.30	.035	.051	
b1	0.80	1.10	.031	.043	2
b2	1.25	1.65	.049	.065	
bЗ	1.10	1.55	.043	.061	2
b4	2.35	2.55	.093	.100	
b5	2.30	2.50	.091	.098	2
b6	1.25	1.65	.049	.065	
b7	1.10	1.55	.043	.061	2
с	0.70	1.00	.028	.039	
c1	0.60	0.90	.024	.035	2
D	14.00	15.00	.0551	.591	3
D1	12.50	13.50	.492	.531	
Е	10.00	11.00	.394	.433	3
E1	8.00	9.00	.315	.354	
е	2.55	BSC	.100	BSC	
e1	3.66	BSC	.144	BSC	
L	13.00	14.50	.512	.571	
L1	3.00	3.50	.118	.138	
L2	0.50	1.50	.020	.059	
L3	3.50	4.00	.138	.157	
L4	-	1.50	-	.059	
ø	42.5*	47.5*	42.5*	47.5 *	
ø1	-	42.5*	-	42.5°	
	-				•

LEAD	ASSIGNMEN	TS

MOSFET 1.- GATE 2.- DRAIN 3.- SOURCE

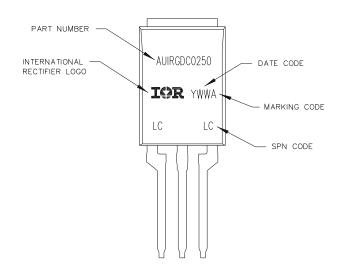
4.- DRAIN

<u>IGBT</u>

1.- GATE 2.- COLLECTOR

3.- EMITTER 4.- COLLECTOR

Super-TO-220 Part Marking Information





	Infineon's Industrial and	Automotive (per AEC-Q101) mber (s) passed Automotive qualification. Consumer qualification level is granted by			
	Infineon's Industrial and	Consumer qualification level is granted by			
	autonaion of the higher A				
	extension of the higher A	utomotive level.			
_evel	3L– Super TO-220 MSL1				
Machine Model	Class M4 [†] (+/- 800V) AEC-Q101-002				
Human Body Model	Class H3A [†] (+/- 6000V) AEC-Q101-001				
Charged Device Model	Class C5 [†] (+/- 2000V) AEC-Q101-005				
RoHS Compliant		Yes			
-1	uman Body Model	uman Body Model			

+ Highest passing voltage.

Revision History

Revision	Date	Subjects (major changes since last revision)
2.0	9/2/2014	Final Datasheet
2.1	12/1/2014	Updated with V _{(BR)CES} and V _{GE(th)} conditions
2.2	3/2/2015	Updated with minor changes
2.3	8/31/2017	Updated with Infineon logo
2.4	03/01/2018	Updated with qualification level
2.5	11/06/2018	Updated maximum V _{CE(on)}
2.6	4/18/2019	Updated typical Vce(on) value @ 150°C



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